

Special Issue

New Horizons and Applications for Big Data Analysis and Smart Computing

Message from the Guest Editor

Cloud and edge computing, along with mobile computing, form the backbone of the Internet of Things (IoT), enabling the seamless connectivity and intelligence of smart devices. Cloud computing provides robust, scalable infrastructure that supports the massive data generated by IoT devices, offering centralized processing power and storage. Mobile computing complements this by offering portability and direct interaction with users through smartphones and tablets, allowing for real-time data access and control. In summary, the integration of cloud/edge computing with mobile computing and IoT technologies is driving innovation, enhancing efficiency, and transforming industries by harnessing the power of connected devices and data-driven insights

Guest Editor

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